

## PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Hidetoshi TAKIMOTO</td><td>04/22/2008</td></tr><tr><td>Takehito YAGI</td><td>04/22/2008</td></tr><tr><td>Yoshiyuki SAITO</td><td>04/22/2008</td></tr><tr><td>Tsuyoshi TERAUCHI</td><td>04/22/2008</td></tr></tbody></table>	Name	Execution Date	Hidetoshi TAKIMOTO	04/22/2008	Takehito YAGI	04/22/2008	Yoshiyuki SAITO	04/22/2008	Tsuyoshi TERAUCHI	04/22/2008	
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Tsuyoshi TERAUCHI	04/22/2008										
RECEIVING PARTY DATA											
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City:	Tokyo										
State/Country:	JAPAN										
PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12108701</td></tr></tbody></table>	Property Type	Number	Application Number:	12108701							
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Application Number:	12108701										
CORRESPONDENCE DATA											
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Total Attachments: 1 source=00924311#page1.tif											

OP \$40.00 12108701

500522290

PATENT  
REEL: 020850 FRAME: 0698

PATENT APPLICATION ASSIGNMENT -  
SOLE OR JOINT INVENTORS  
EXECUTED OUTSIDE U.S.A.

08P00258 OSP-26114 <sup>US</sup> 1/1  
P/2850-227 (V7627)  
OFGS FILE NO. ( )

WHEREAS, I (We), (1) Hidetoshi TAKIMOTO, (2) Takehito YAGI, (3) Yoshiyuki SAITO, and (4) Tsuyoshi TERAUCHI as assignor(s), have invented certain improvements in

FILM THICKNESS MEASUREMENT DEVICE AND METHOD for which  
an application for United States Letters Patent has been executed by me (us) of even date herewith; and

WHEREAS, IHI Corporation, 1-1, Toyosu 3-chome, Koto-ku, Tokyo, Japan as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I (We), as assignor(s), hereby sell, assign and set over to said assignee the entire right, title and interest for the United States in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute, reissue or reexamination applications and patents applied for or granted therefor in the United States and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for myself (ourselves) and my (our) legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States, the expenses incident to said applications to be borne and paid by said assignee.

Date: April 22, 2008

Hidetoshi Takimoto  
Hidetoshi TAKIMOTO

Date: April 22, 2008

Takehito Yagi  
Takehito YAGI

Date: April 22, 2008

Yoshiyuki Saito  
Yoshiyuki SAITO

Date: April 22, 2008

Tsuyoshi Terauchi  
Tsuyoshi TERAUCHI

LEGALIZATION RECOMMENDED